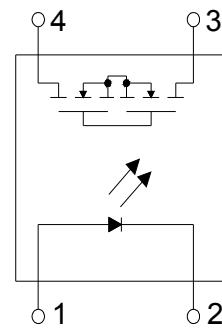


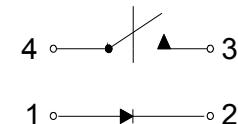
● Description

The KAQY212 series is robust, ideal for telecom and ground fault applications. It is a SPST normally open switch (1 Form A) that replaces electromechanical relays in many applications. It is constructed using a GaAlAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high-voltage dielectrically isolated technology, is comprised of a photodiode array, switch control circuitry and MOSFET switches.

● Schematic



1 FORM A
NORMALLY OPEN



● Features

1. Normally open, single pole single throw
2. Control 60V AC or DC voltage
3. Switch 400mA loads
4. Controls low-level analog signals
5. High sensitivity, low ON resistance
6. Low-level off-state leakage current
7. High isolation voltage 5KV (DIP / SMD)
8. Pb free and RoHS compliant
9. MSL class 1
10. Agency Approvals :
 - UL Approved (No. E108430): UL508
 - c-UL Approved (No. E108430)
 - FIMKO Approved: EN60065, EN60950

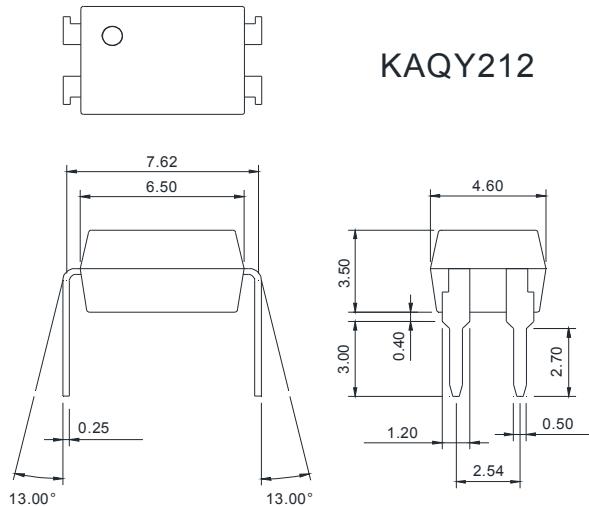
● Application

- Telecommunications (PC, electronic notepad)
- Modem
- Telephone equipment
- Security equipment
- Sensors
- Measuring and testing equipment
- Factory automation equipment
- High speed inspection machines

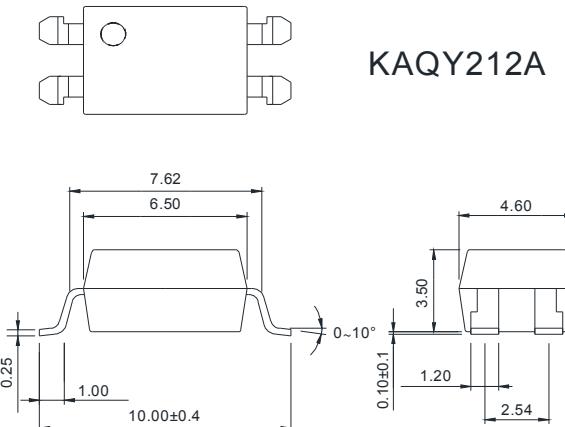
● Outside Dimension

Unit : mm

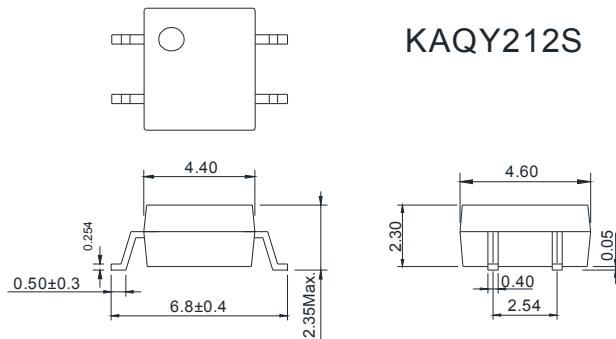
1. Dual-in-line type.



2. Surface mount type.



3. Small outline for surface mount type.



TOLERANCE : ±0.2mm

● Device Marking



Notes :

cosmo

Y212□ □ : Pin forming

YWW Y : Year code / W : Week code

● **Absolute Maximum Ratings**

(Ta=25°C)

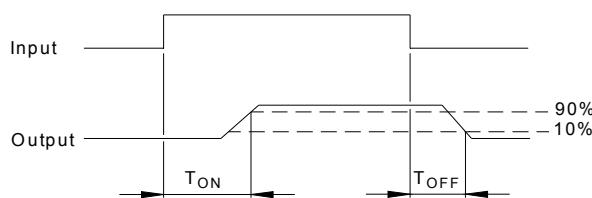
Item	Symbol	Rating	Unit
Input	Continuous forward current	I _F	50 mA
	Peak forward current	I _{FP}	1 A
	Reverse voltage	V _R	5 V
	Power dissipation	P _{in}	100 mW
	Derate linearly from 25°C	-	mW/°C
Output	Breakdown voltage	V _B	60 V
	Continuous load current	I _L	400 mA
	Power dissipation	P _{out}	500 mW
Isolation voltage		KAQY212S	KAQY212
		1500Vrms	5000Vrms
Isolation resistance (V _{io} =500V)	R _{iso}	≥10 ¹⁰ Ω	
Total power dissipation	P _t	550 mW	
Derate linearly from 25°C	-	2.5 mW/°C	
Operating temperature	T _{opr}	-40 to +85 °C	
Storage temperature	T _{stg}	-40 to +125 °C	
Junction temperature	T _j	100 °C	
Soldering temperature 10 seconds	T _{sot}	260 °C	

● **Electro-optical Characteristics**

(Ta=25°C)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Input	Forward voltage	V _F	I _F =10mA	-	1.2	1.5 V
	Operation input current	I _{FON}	V _L =20V, I _L =100mA	-	-	3.0 mA
	Recovery input current	I _{FOFF}	V _L =20V, I _L ≤5μA	0.2	-	- mA
Output	Breakdown voltage	V _B	I _B =50μA	60	-	- V
	Off-state leakage current	I _{LEAK}	V _L =60V, I _F =0mA	-	0.2	1.0 μA
I/O capacitance	C _{iso}	V _B =0V, f=1MHz	-	6	-	pF
ON resistance	R _{ON}	I _F =10mA, I _L =100mA	-	0.83	2.5 Ω	
Turn-on time	T _{ON}	I _F =10mA, V _L =20V I _L =100mA, t=10ms	-	0.3	1.5 ms	
Turn-off time	T _{OFF}		-	0.1	1.5 ms	

● **Turn-on / Turn-off Time**



- Schematic and Wiring Diagrams

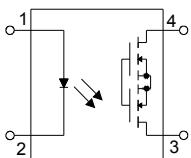
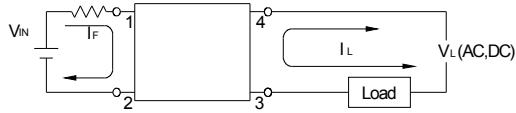
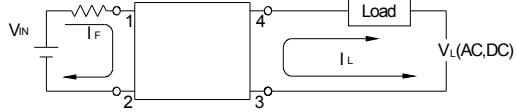
Schematic	Output Configuration	Load	Connection	Wiring Diagrams
	1a	AC DC	-	 

Fig.1 Load Current vs. Ambient Temperature

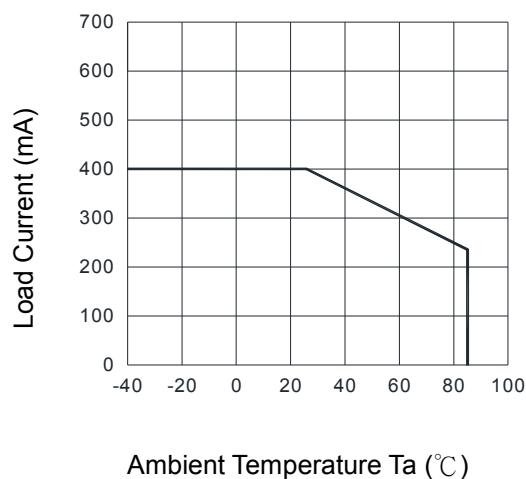


Fig.3 Turn-on Time vs. Ambient Temperature

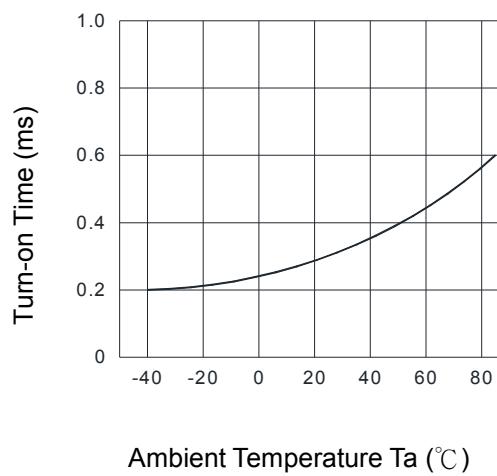


Fig.5 LED Operate Current vs. Ambient Temperature

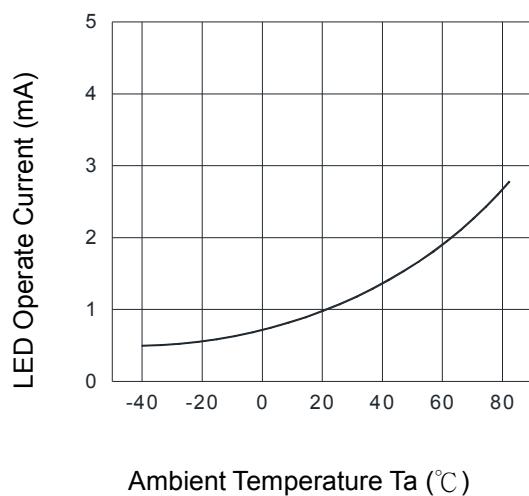


Fig.2 On Resistance vs. Ambient Temperature

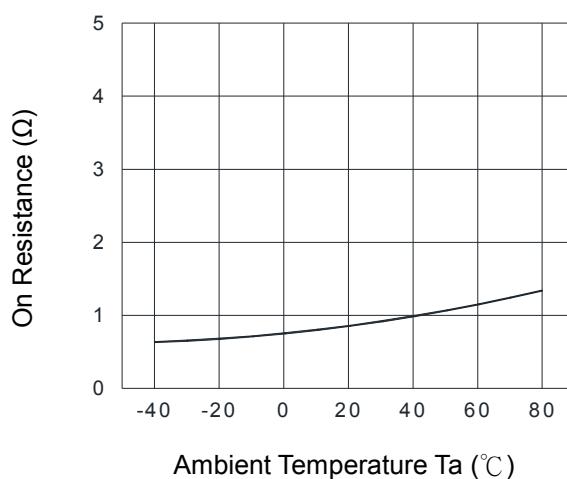


Fig.4 Turn-off Time vs. Ambient Temperature

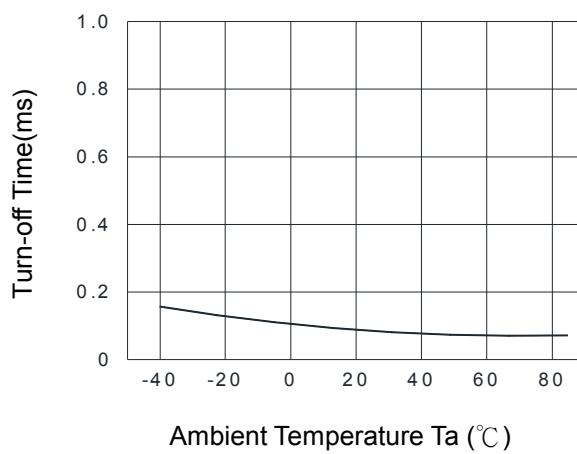


Fig.6 LED Turn-off Current vs. Ambient Temperature

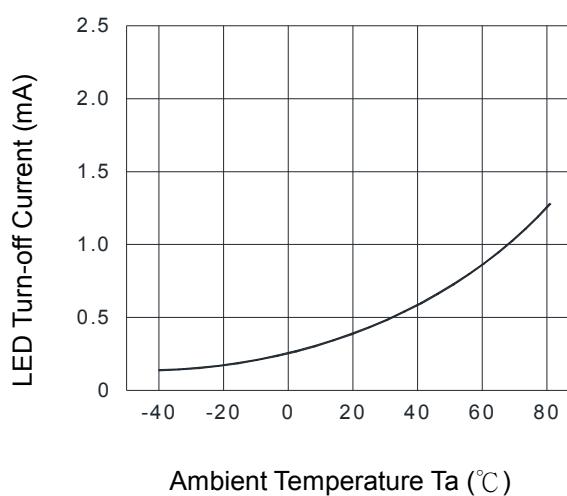


Fig.7 LED Dropout Voltage vs. Ambient Temperature

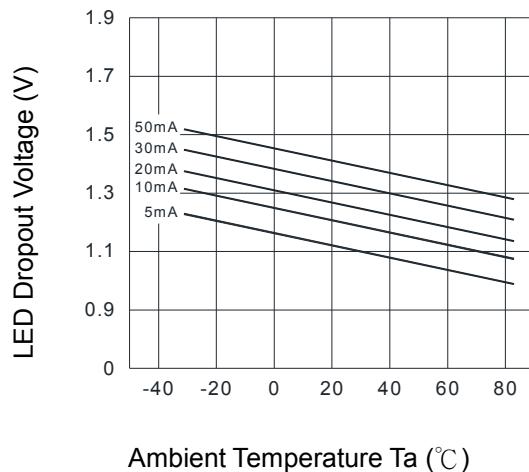


Fig.8 Voltage vs. Current Characteristics of Output at MOSFET Portion

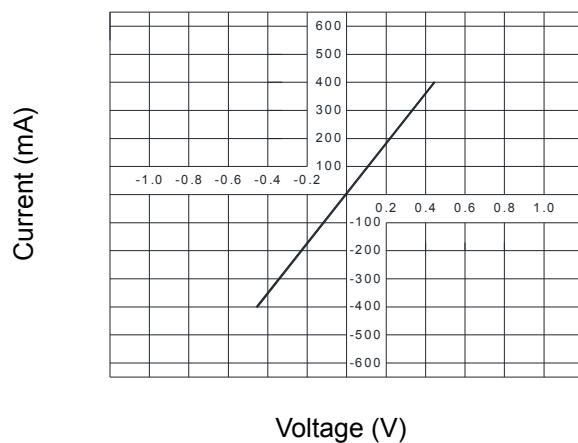


Fig.9 Turn-on Time vs. LED Forward Current

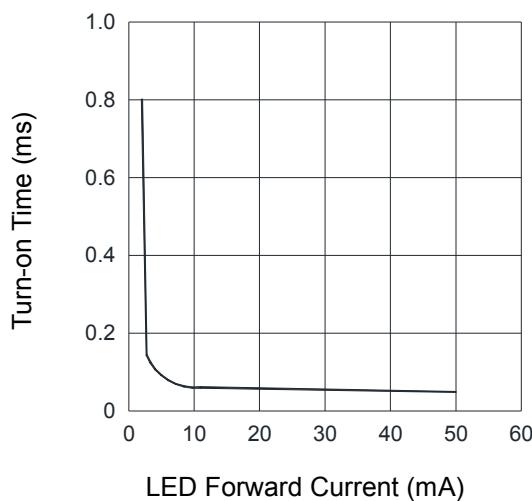


Fig.10 Off-state Leakage Current vs. Load Voltage

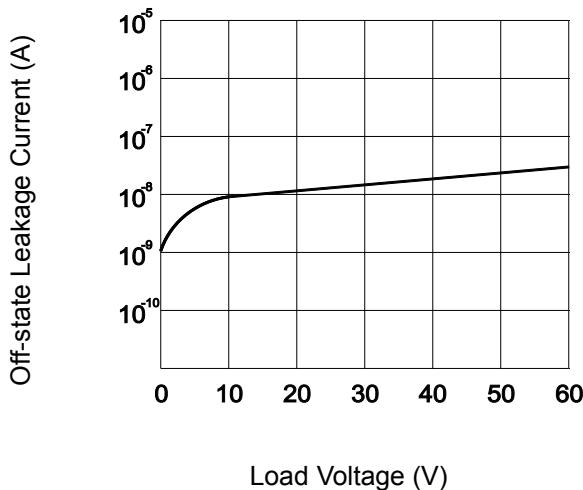


Fig.11 Turn-off Time vs. LED Forward Current

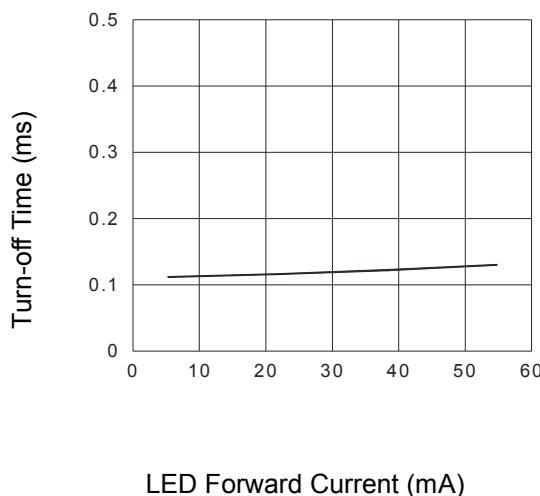
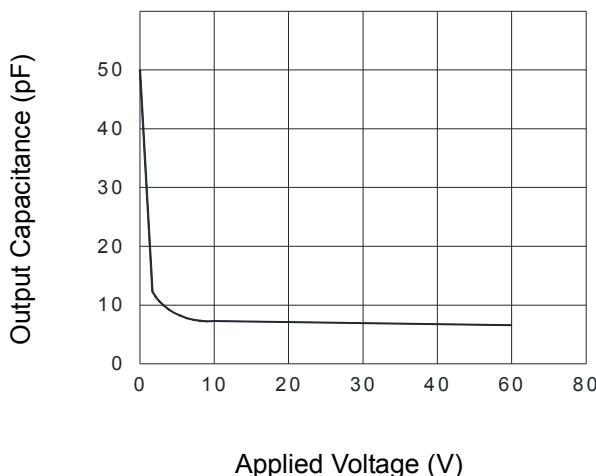
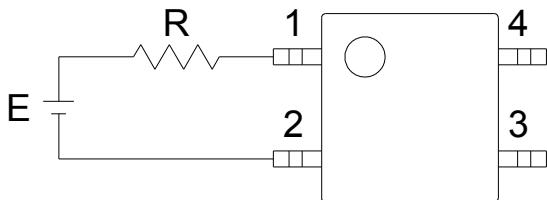


Fig.12 Output Capacitance vs. Applied Voltage



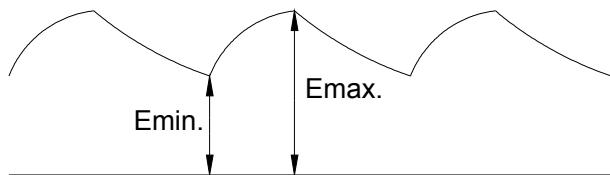
● Using Methods

Examples of resistance value to control LED forward current ($I_F=5mA$)

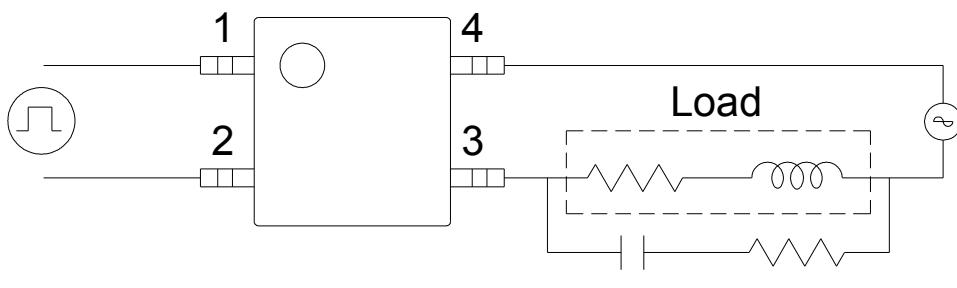
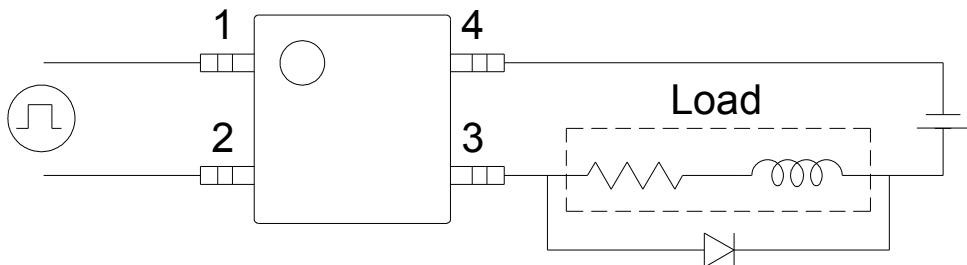


E	R
3.3V	Approx. 330 Ω
5V	Approx. 640 Ω
12V	Approx. 1.9K Ω
15V	Approx. 2.5K Ω
24V	Approx. 4.1K Ω

1. LED forward current must be more than 5mA · at E min.
2. LED forward current must be less than 50mA · at E max.



Regulate the spike voltage generated on the inductive load as follows :



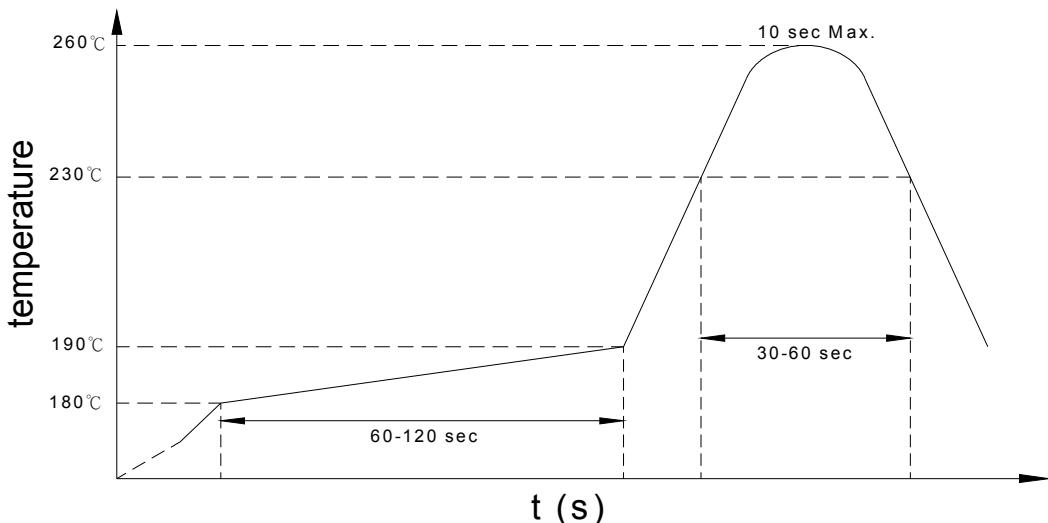
R-C Snubber

● Recommended Soldering Conditions

(a) Infrared reflow soldering :

- Peak reflow soldering : 260°C or below (package surface temperature)
- Time of peak reflow temperature: 10 sec
- Time of temperature higher than 230°C : 30-60 sec
- Time to preheat temperature from 180~190°C : 60-120 sec
- Number of reflows : Two
- Flux : Rosin flux containing small amount of chlorine
(The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(b) Wave soldering :

- Temperature : 260°C or below (molten solder temperature)
- Time : 10 seconds or less
- Preheating conditions: 120°C or below (package surface temperature)
- Number of times : One
- Flux : Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(c) Cautions :

- Fluxes : Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.
- Avoid shorting between portion of frame and leads.

- Numbering System

KAQY212 X (Y)

Note :

KAQY212 = Part No.

X = Lead form option (blank , S or A)

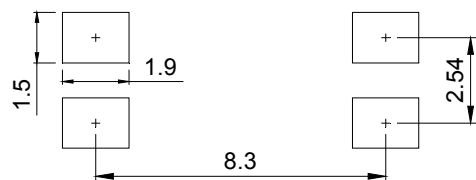
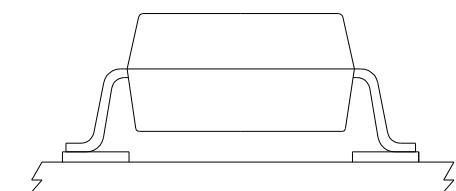
Y = Tape and reel option (TLD , TRU , TL , TR)

Option	Description	Packing quantity
A (TLD)	surface mount type package + TLD tape & reel option	2000 units per reel
A (TRU)	surface mount type package + TRU tape & reel option	2000 units per reel
S (TL)	small outline for surface mount type package + TL tape & reel option	2000 units per reel
S (TR)	small outline for surface mount type package + TR tape & reel option	2000 units per reel

- Recommended Pad Layout for Surface Mount Lead Form

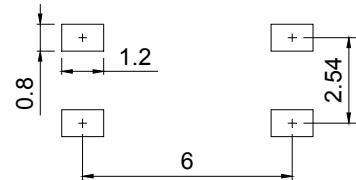
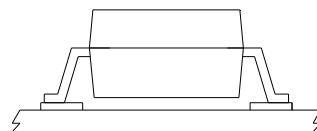
1. Surface mount type.

4-pin SMD



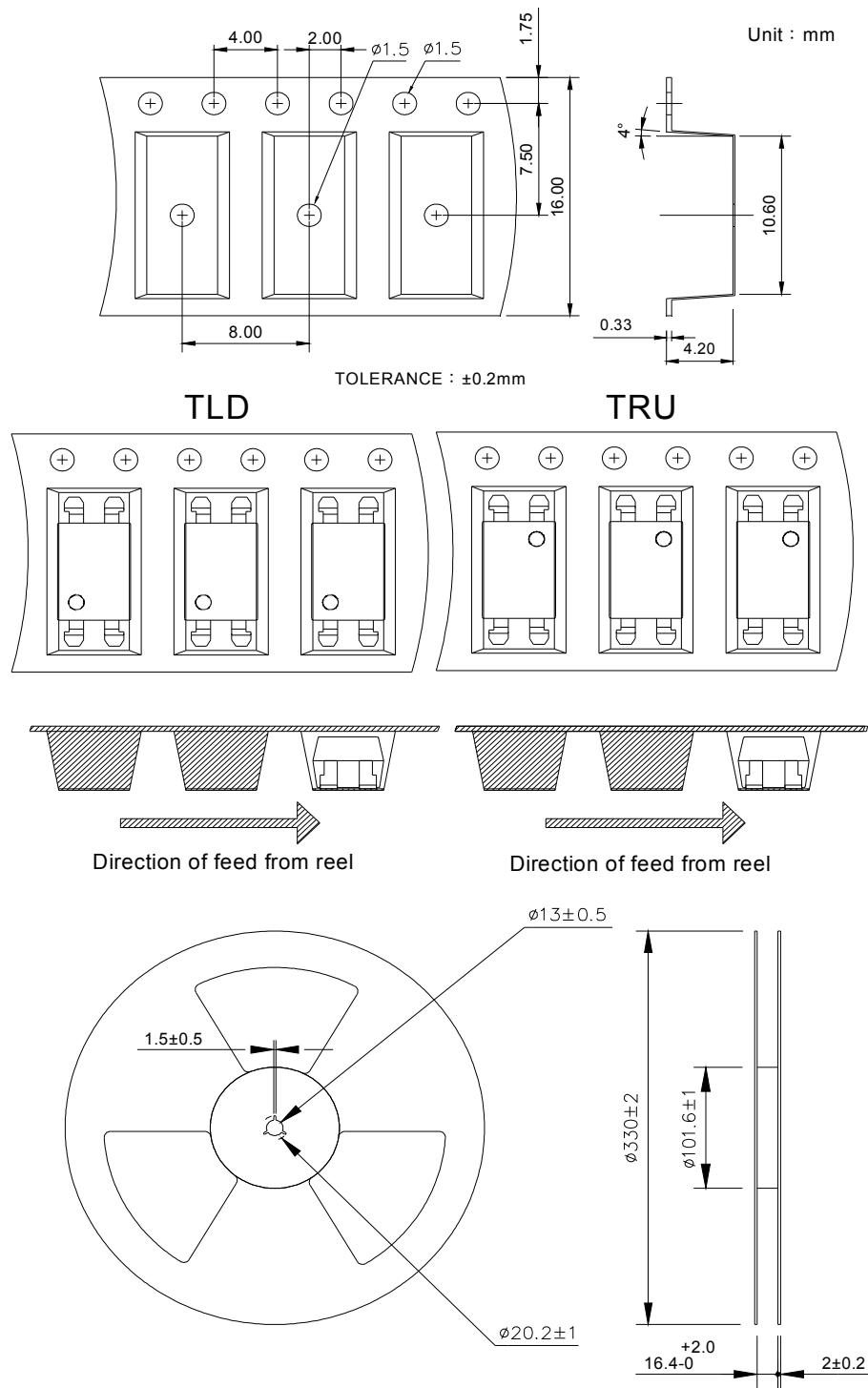
**2. Small outline for
surface mount type.**

4-pin SOP

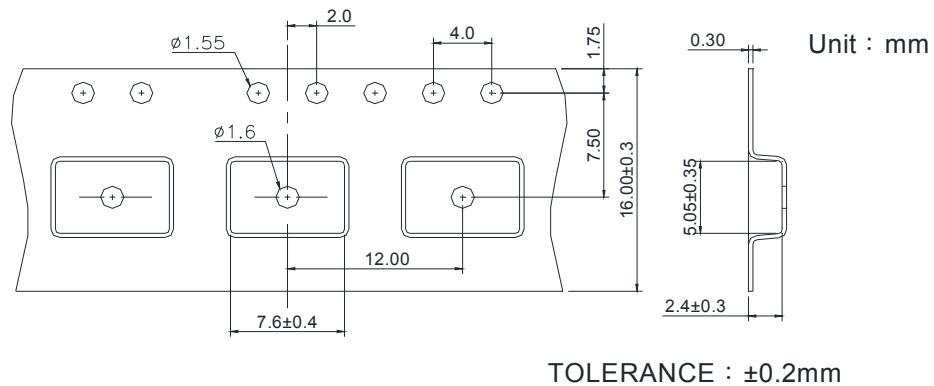


Unit : mm

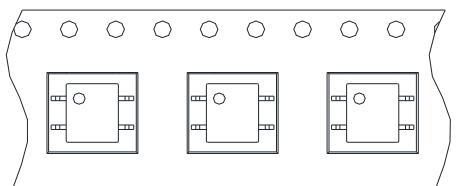
- 4-pin SMD Carrier Tape & Reel



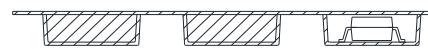
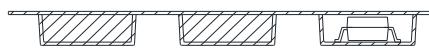
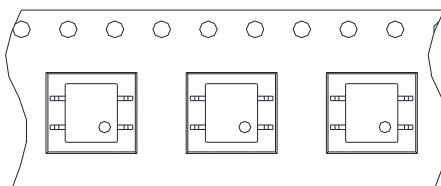
● 4-pin SOP Carrier Tape & Reel



TL

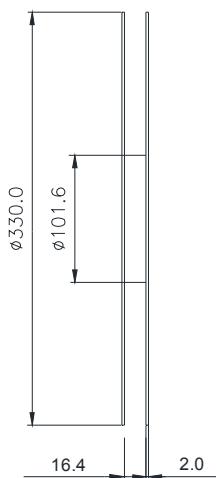
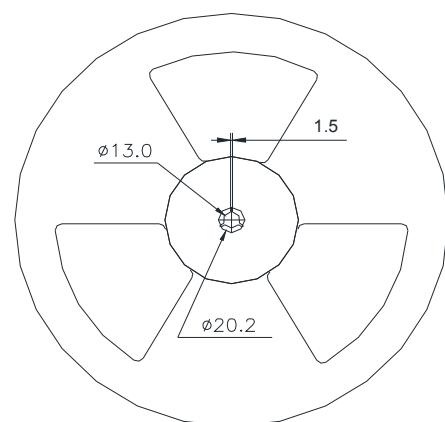


TR



Direction of feed from reel

Direction of feed from reel



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- d. Instrumentation
- e. Electrical application
- f. Measurement equipment
- g. Consumer electronics
- h. Telecommunication

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- d. Nuclear power control
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